

AMENDMENT

Please amend claim 28 to read as follows:

28. (Amended) A lamination ceramic chip inductor, according to claim 25, wherein the at least one pair of insulation layers are magnetic.

A version of the above amended claim marked to indicate the specific amendments may be found in the attached Appendix, in accordance with 37 CFR 1.121(c)(1).

Please add the following new claims 29-38:

29. (Newly Added) A lamination ceramic chip inductor, comprising at least one conductive pattern formed between at least one pair of insulation layers so as to have no specific gap between the at least one conductive pattern and the at least one pair of insulation layers.

30. (Newly Added) A lamination ceramic chip inductor, according to claim 29, wherein a plurality of conductive patterns are included, and at least two of the conductive patterns are electrically connected to each other by a thick film conductor formed by printing.

31. (Newly Added) A lamination ceramic chip inductor, according to claim 30, wherein the plurality of conductive patterns include an electroformed conductive pattern having a shape of a straight line.

32. (Newly Added) A lamination ceramic chip inductor, according to claim 29, wherein the at least one pair of insulation layers are magnetic.

33. (Newly Added) A lamination ceramic chip inductor according to claim 29, wherein the lamination ceramic chip inductor has a high impedance at a low resistance while comprising a small number of layers.

34. (Newly Added) A lamination ceramic chip inductor, comprising at least one conductive pattern formed by an electroforming process using a photoresist, wherein the at least one conductive pattern is formed between at least one pair of insulation layers so as to have no specific gap therebetween.

35. (Newly Added) A lamination ceramic chip inductor, according to claim 34, wherein a plurality of conductive patterns are included, and at least two of the conductive patterns are electrically connected to each other by a thick film conductor formed by printing.

36. (Newly Added) A lamination ceramic chip inductor, according to claim 35, wherein the plurality of conductive patterns include an electroformed conductive pattern having a shape of a straight line.